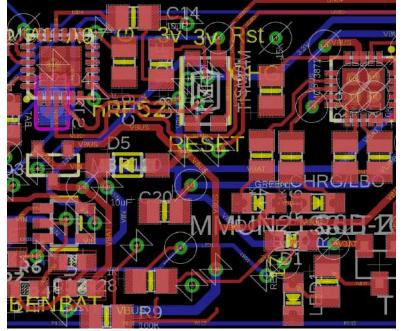
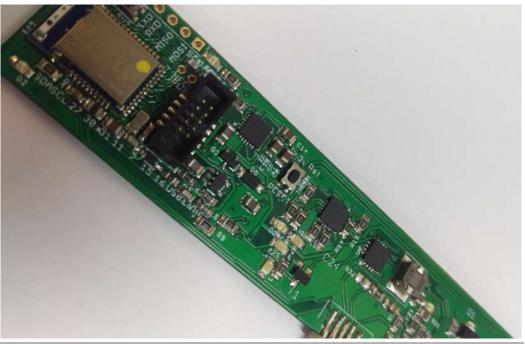
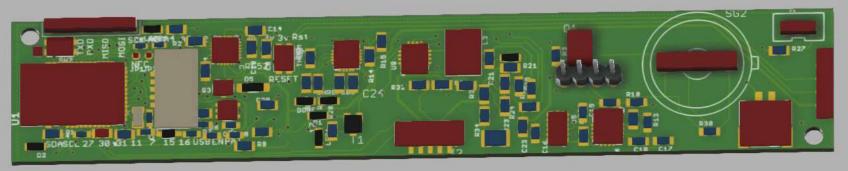
Soldering basics

Duaa Alaali - Fab Lab Bahrain



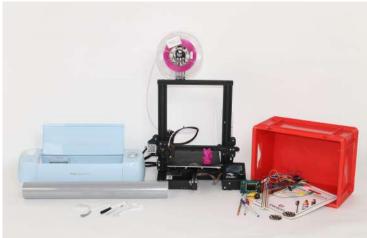








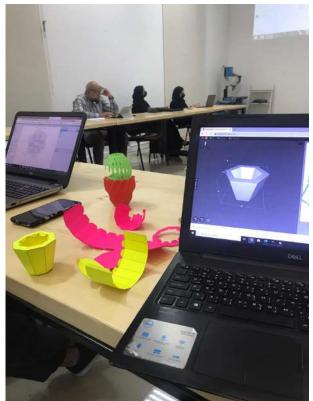




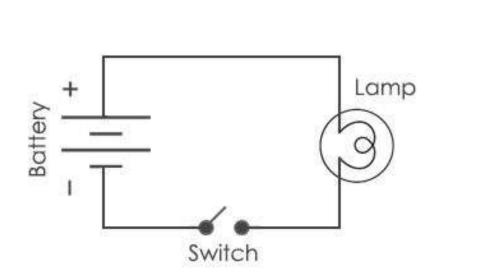


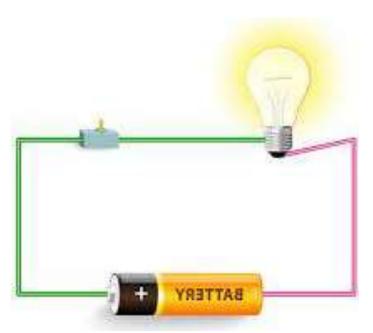


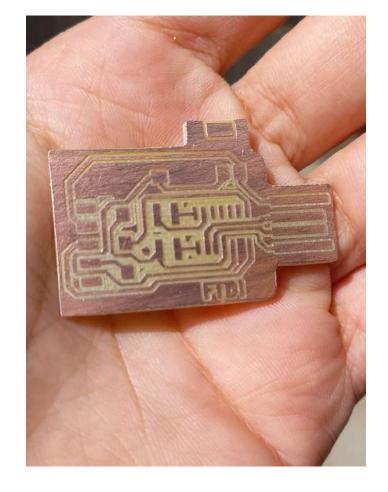


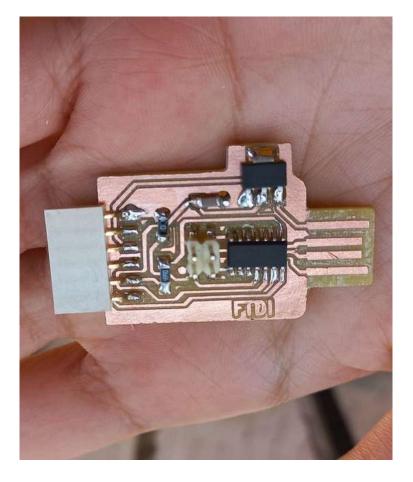


What is soldering









By Amany Ayman: http://fabacademy.org/2022/labs/egypt/students/amany-ayman/pcbp.html



The Fab Academy 2023

Schedule

Labs

Students

Presentations

Documents

Projects

Prior Years

Search:

By Fab foundation: http://fabacademy.org/2023/



The Fab Academy 2023 Schedule (tentative)

Jan 12-16: instructor boot camp

Jan 19-24: student boot camp, project presentations

Jan 25: principles and practices (video), project management (video, review)

Jan 30 recitation: <u>version control</u> (<u>video</u>)
Feb 01: computer-aided design (<u>video</u>, review)

Feb 08: computer-controlled cutting (video, review)

Feb 13 recitation: parametric, algorithmic, generative design (video)

Feb 15: embedded programming (video, review)

Feb 22: 3D scanning and printing (video, review)

Feb 27 recitation: <u>debugging</u> (<u>video</u>) Mar 01: <u>electronics design</u> (<u>video</u>, <u>review</u>)

Mar 08: computer-controlled machining (video, review)

Mar 13 recitation: programming (video)

Mar 15: <u>electronics production</u> (<u>video</u>, <u>review</u>)

Mar 22: molding and casting (video, review)

Mar 27 recitation: machine building (video)

Mar 30: output devices (video, review)

Apr 05: mechanical design, machine design (video, review)

The tools

Solder wire





Image shown is a representation only, Exact specifications should be obtained from the product data sheet.

SMDSWLF.020 40Z

Digi-Key Part Number SMDSWLF.02040Z-ND

Manufacturer Chip Quik Inc.

Manufacturer Product Number SMDSWLF.020 40Z

Supplier Chip Quik Inc.

Description SLD WIRE NO-CLEAN 96.5/3/.5 40Z.

Manufacturer Standard Lead Time 3 Weeks

Detailed Description Lead Free No-Clean, Water Soluble Wire Solder

Sn96.5Ag3Cu0.5 (96.5/3/0.5) 24 AWG, 25 SWG Spool,

4 oz (113.40g)

Customer Reference

Customer Reference

Datasheet



Datasheet

Composition Diameter Melting Point Flux Type Wire Gauge Process Soure: https://www.digikey.com/en/products/detail/chip-quik-inc/SMDSWLF-020-4OZ/2177058

Sn96.5/Ag3.0/Cu0.5

Tin/Silver/Copper

TYPE	DESCRIPTION
Category	Soldering, Desoldering, Rework Products Solder
Mfr	Chip Quik Inc.
Series	
Package	Spool
Part Status	Active
Туре	Wire Solder

DECODIDATION

Sn96.5Ag3Cu0.5 (96.5/3/0.5)

423 ~ 428°F (217 ~ 220°C)

No-Clean, Water Soluble

0.020" (0.51mm)

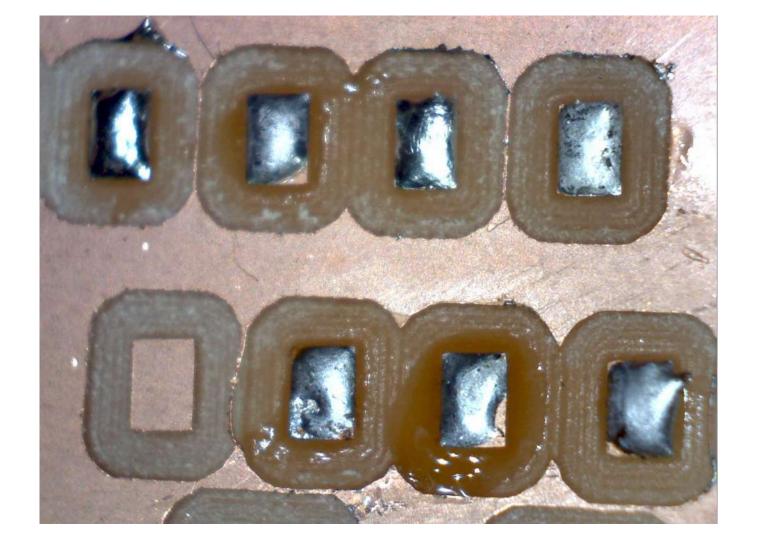
24 AWG, 25 SWG

Lead Free

Product Attributes

TVDE





Soldering iron

The most important part.
An iron will heat up to melt the solder. Some have temperature control and some don't. 25 watt iron minimum is recommended



__

Solder tip

The point of contact with the solder. There are different types for different purposes. Generally you need a fine tip for accurate soldering.



By Weller® - Apex Tool Group

Stand

a safe place to rest the hot iron between uses. It will keep your iron from rolling around and protect both you and your work surface from burns.



Tip cleaners

To keep the soldering tip clean while soldering.

Use it after every use



Flux pen (optional)

The flux is the substance that prevents beading of the solder and helps the solder flow cleanly onto the parts you are soldering



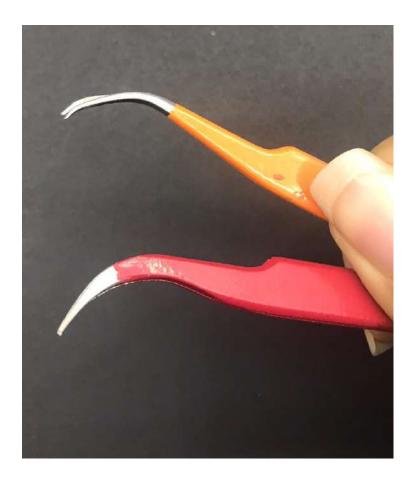


tweezers

Necessary for holding small components without burning your hands







Vise (optional)

keeps your electronic board in place while you solder



__

Third Hand (optional)

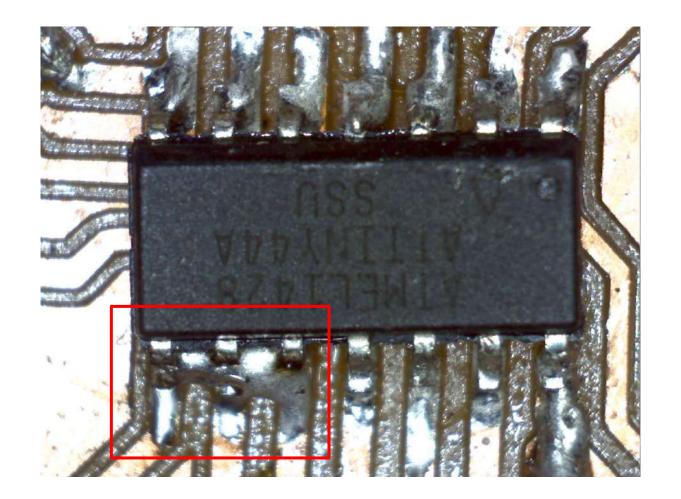
keeps your electronic board in place while you solder and helps you see your solder joints better



—

Digital microscope (optional)





Solder Sucker

Great for desoldering.
Sucks the solder out from the joint



__

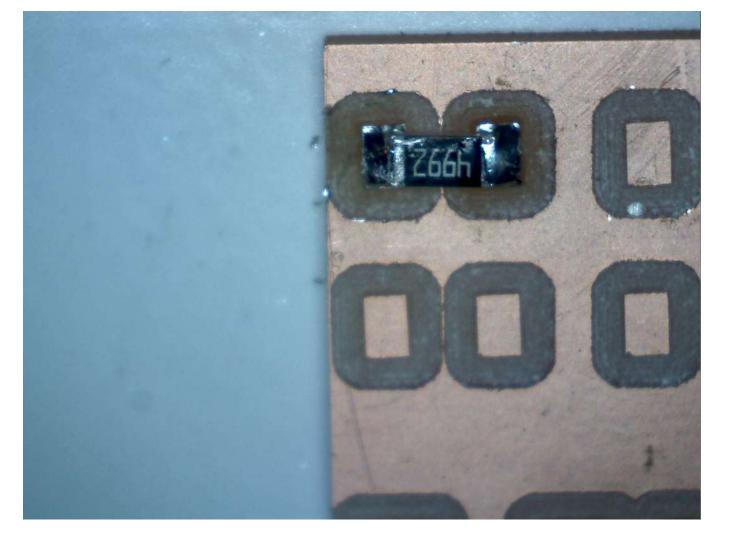
Solder wix

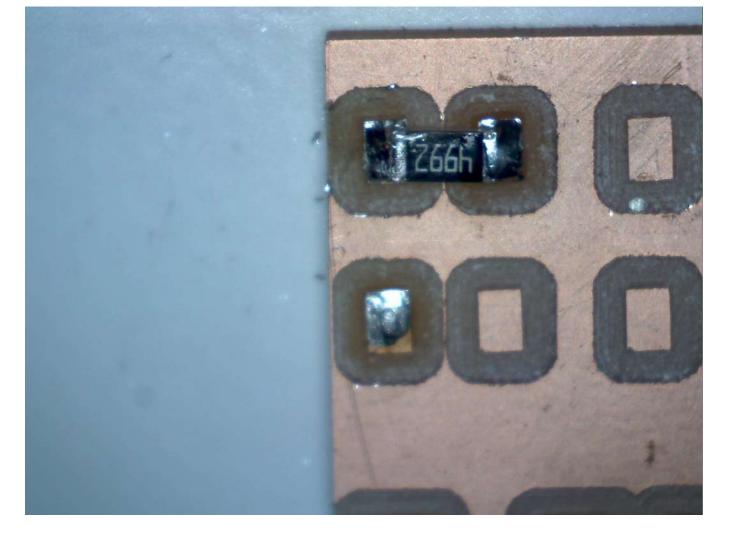
Great for desoldering. Absorbs the solder out from the joint

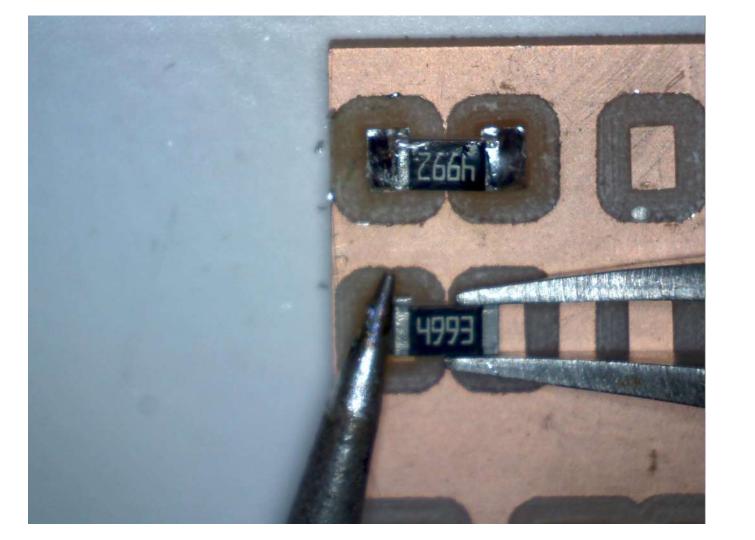


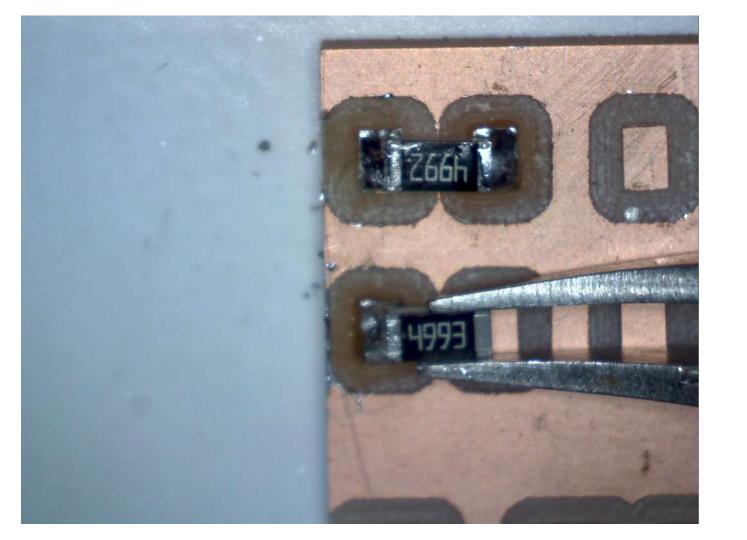


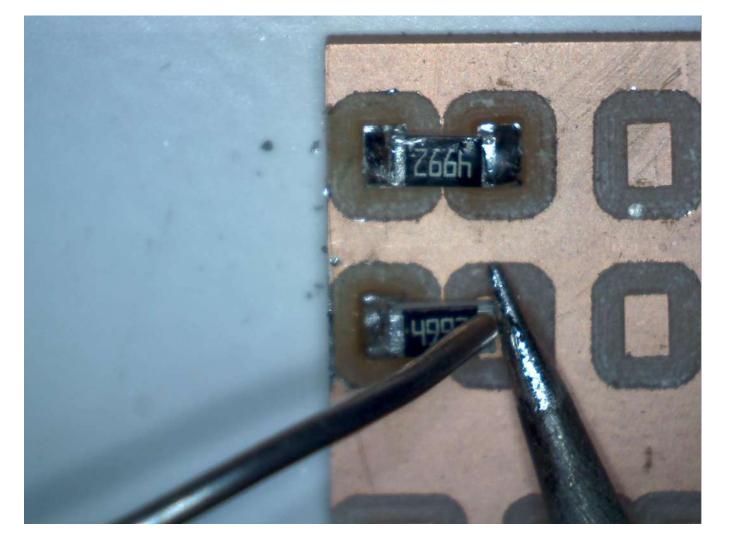
Soldering

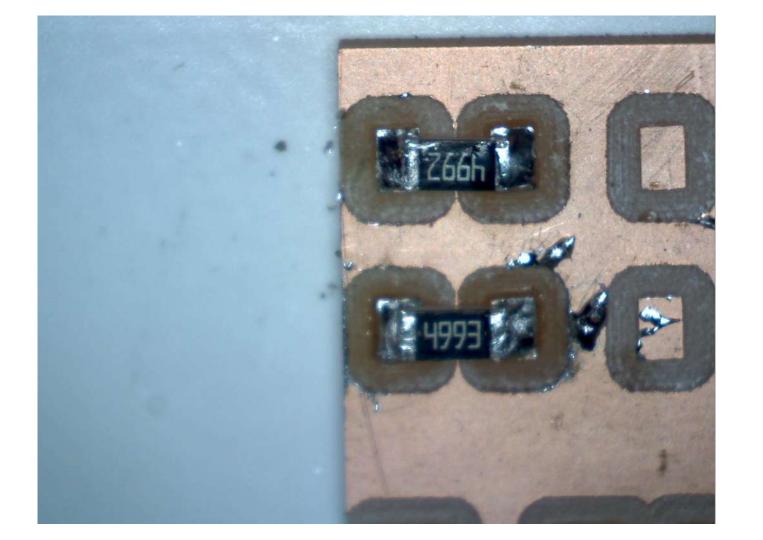


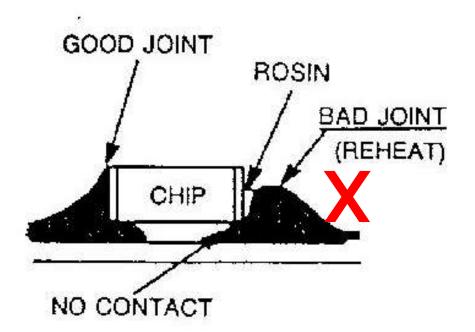




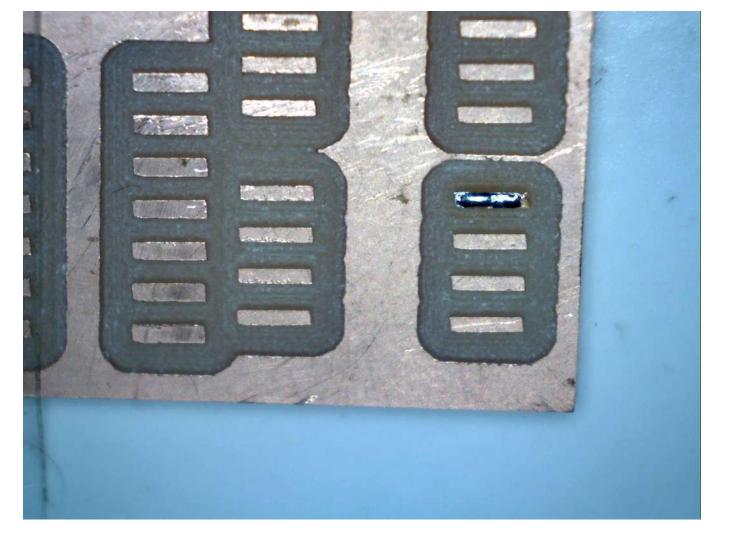


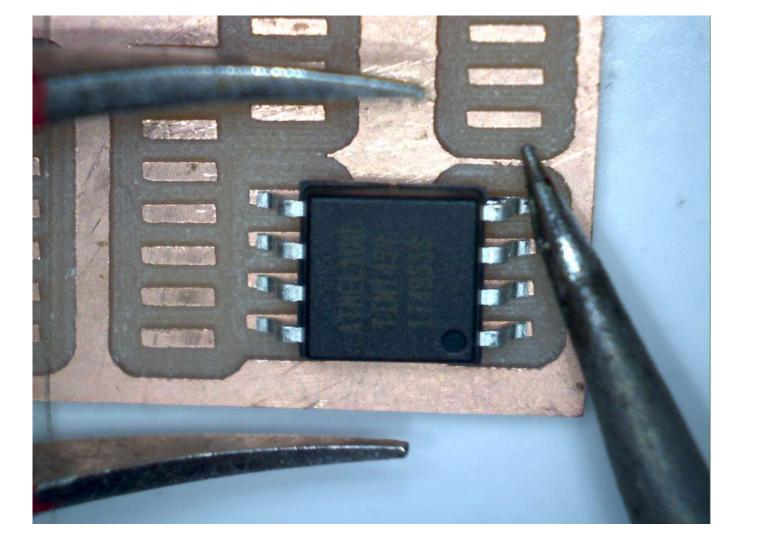


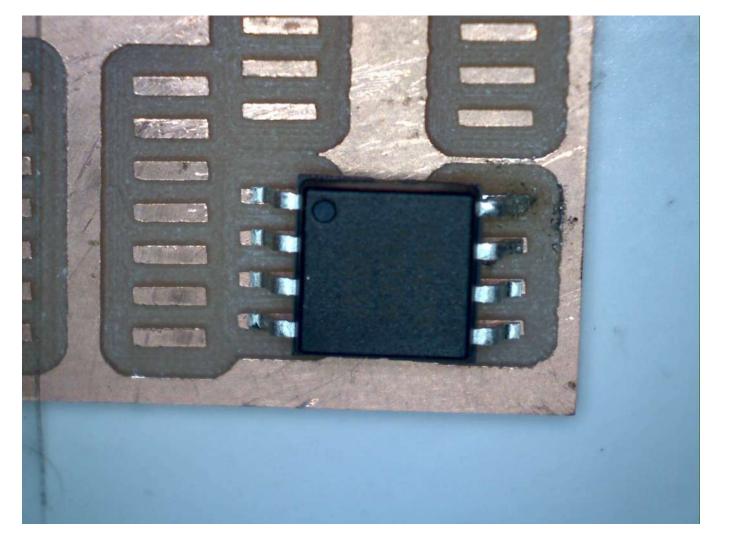


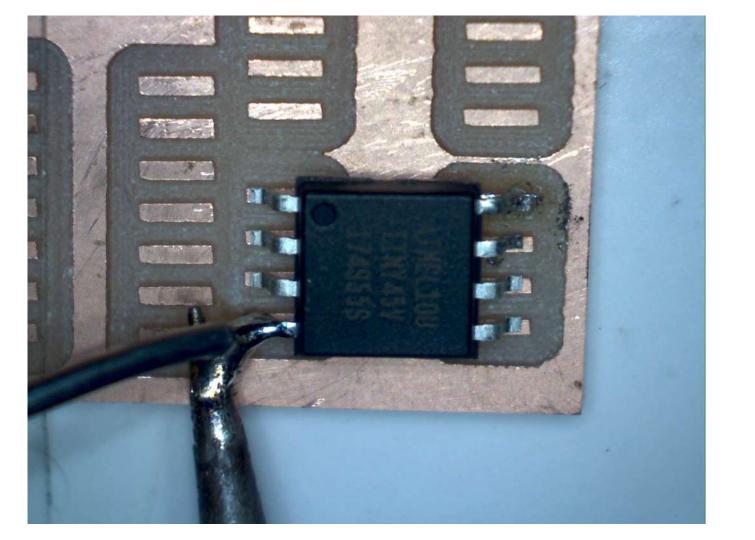


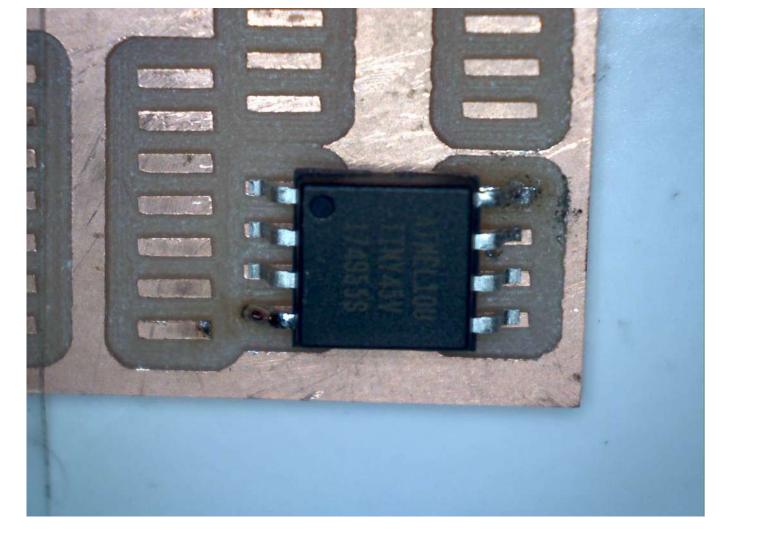


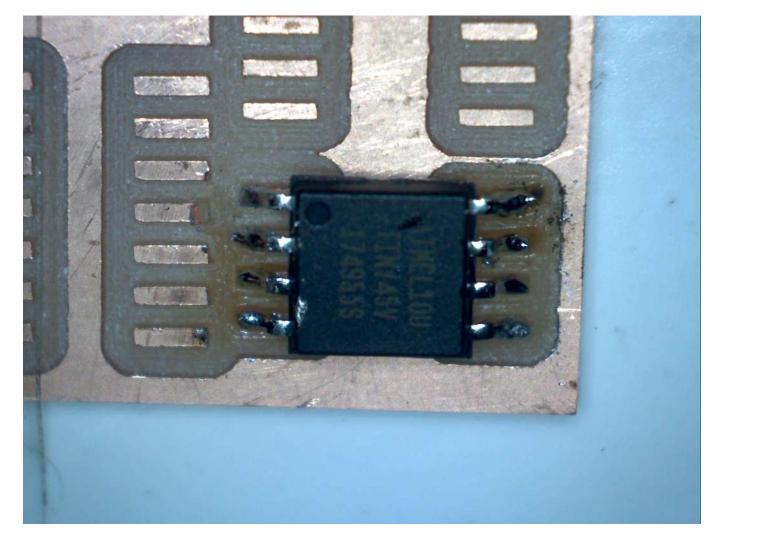


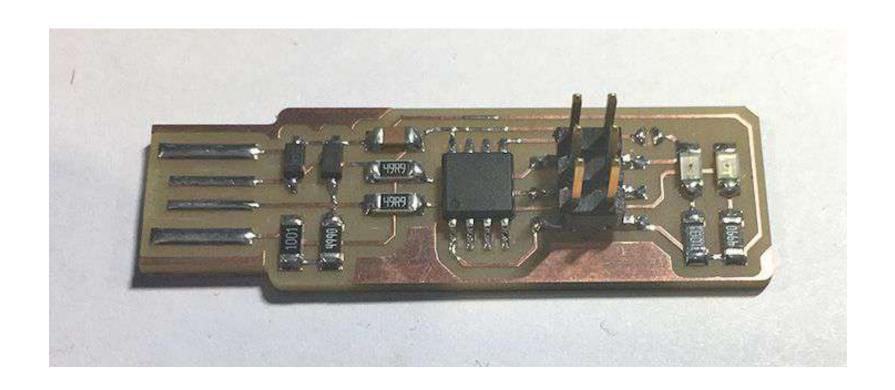






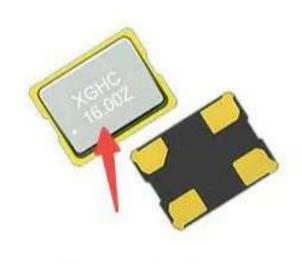




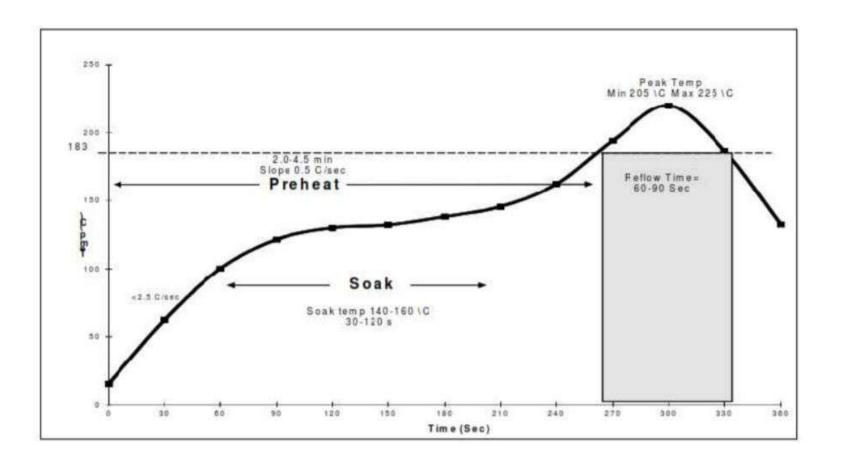


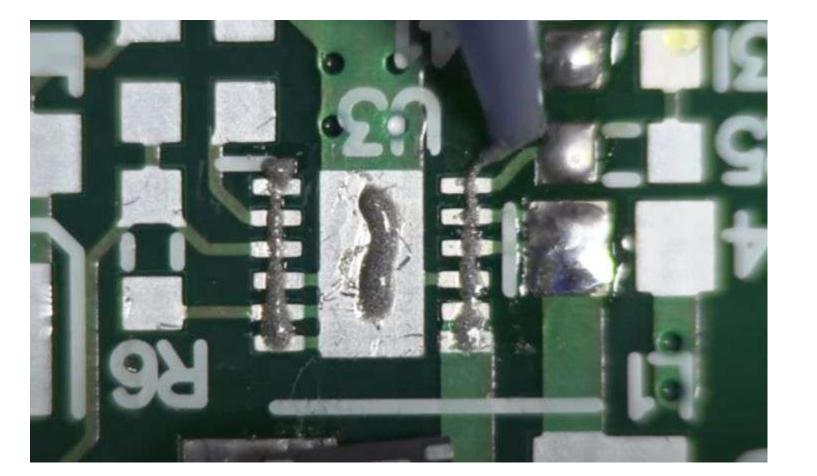
By Brian: http://fab.cba.mit.edu/classes/863.16/doc/projects/ftsmin/index.html

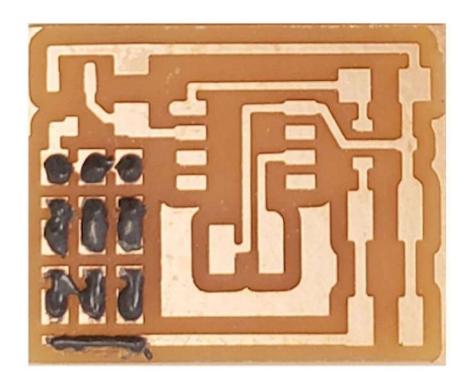
Reflow soldering

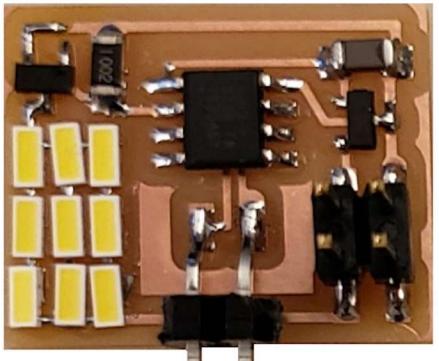


By: https://leadsintec.com/how-to-identify-smd-components-fast-and-easy-from-appearances/









By Neil Gershenfeld: http://academy.cba.mit.edu/classes/output_devices/LEDs/hello.LEDs.t412.jpg







Picture from: https://www.amazon.com/TOAUTO-Soldering-Conversion-Temperature-Correction/dp/B08L8YGYQZ?th=1



Image shown is a representation only. Exact specifications should be obtained from the product data sheet.

TS391SNL

Digi-Key Part Number TS391SNL-ND

Manufacturer Chip Quik Inc.

Manufacturer Product Number TS391SNL

Supplier Chip Quik Inc.

Description THERMALLY STABLE SOLDER PASTE NO

Manufacturer Standard Lead Time 3 Weeks

Detailed Description Lead Free No-Clean Solder Paste Sn96.5Ag3Cu0.5

(96.5/3/0.5) - Syringe, 0.53 oz (15g), 5cc

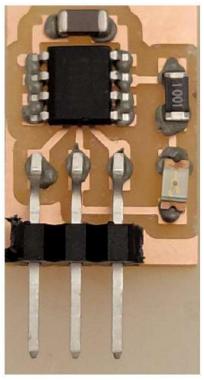
Customer Reference

Customer Reference

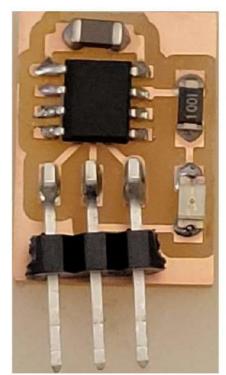
Composition	Sn96.5Ag3Cu0.5 (96.5/3/0.5)
Diameter	(4)
Melting Point	423 ~ 428°F (217 ~ 220°C)
Flux Type	No-Clean
Wire Gauge	20
Mesh Type	4
Process	Lead Free
Form	Syringe, 0.53 oz (15g), 5cc
Shelf Life	12 Months
Shelf Life Start	Date of Manufacture
Storage/Refrigeration Temperature	68°F ~ 77°F (20°C ~ 25°C)

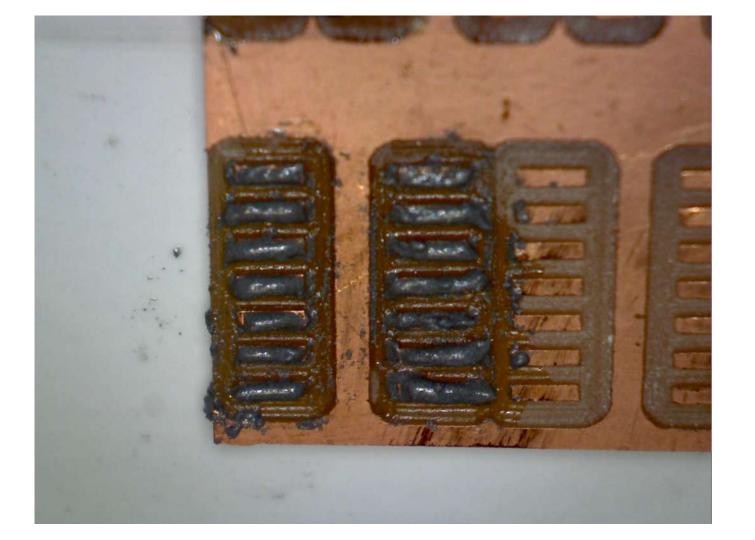
Screenshot from: https://www.digikey.com/en/products/detail/chip-quik-inc/TS391SNL/7802215

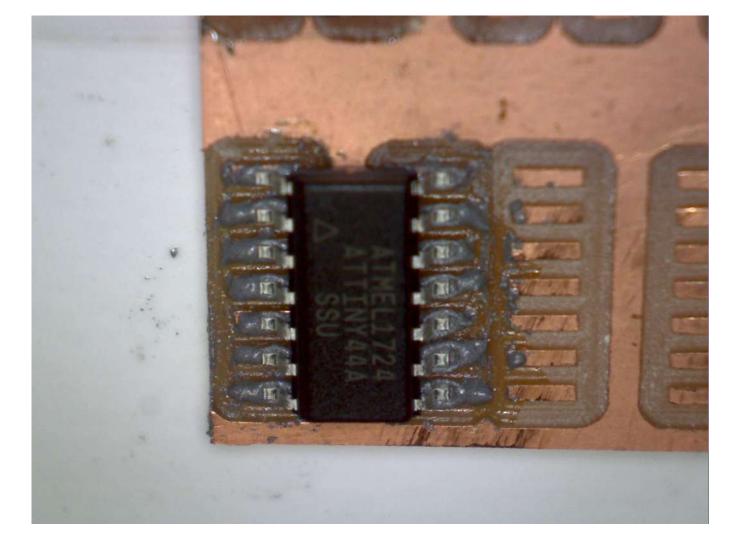


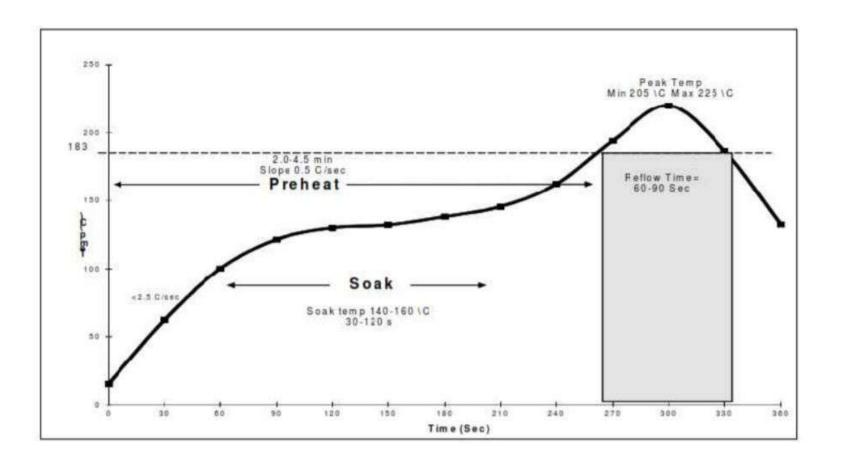




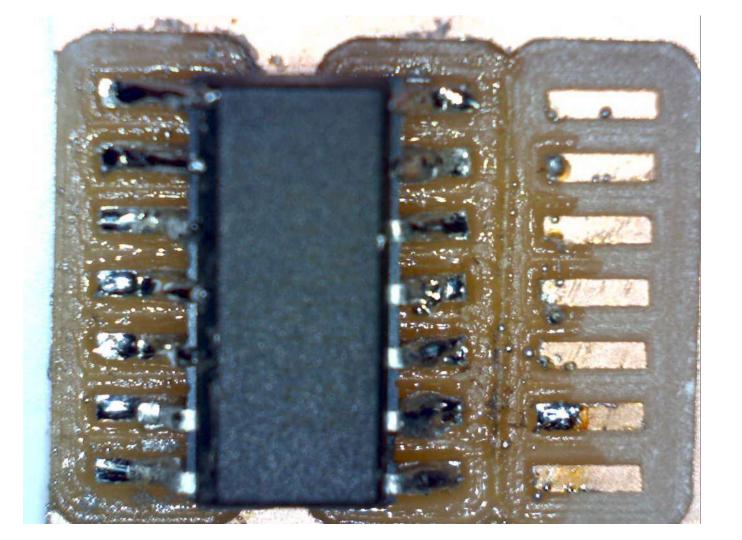






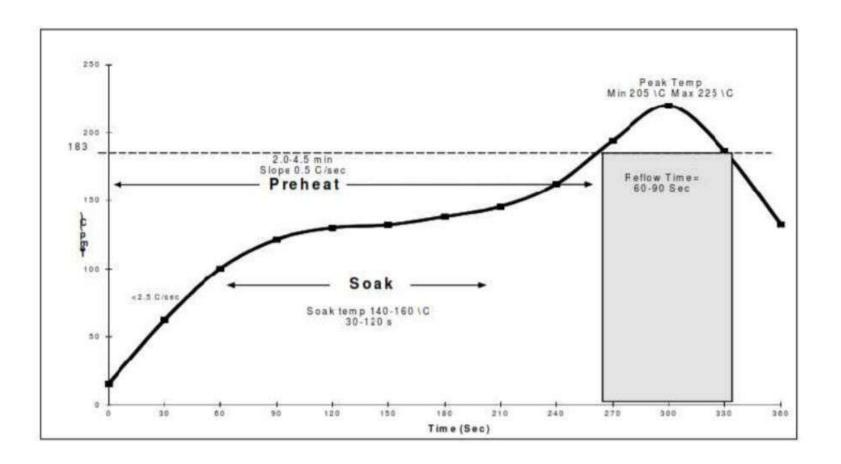


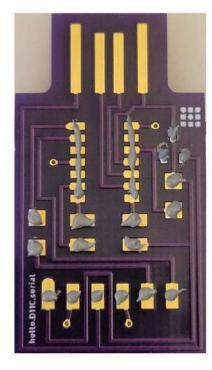


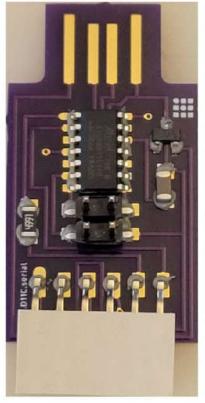




Picture from: https://www.amazon.com/SainSmart-Soldering-Preheating-Preheater-Intelligent/dp/B08R6XFPKR?th=1



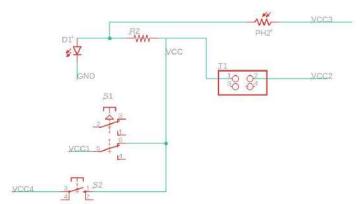




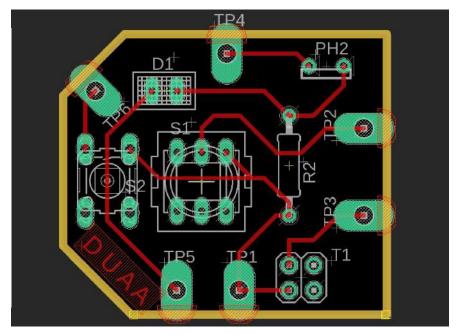


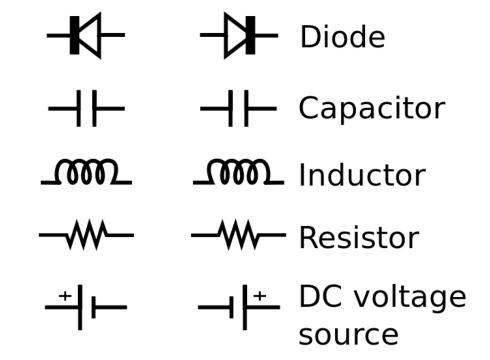


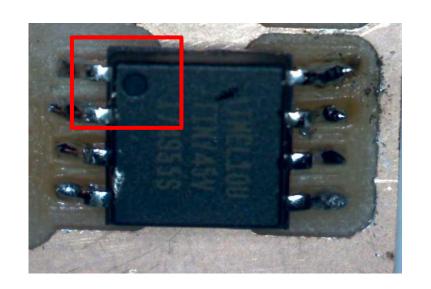
What to solder where?

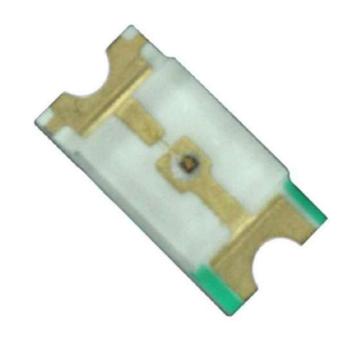












https://www.digikey.com/en/product s/detail/dialight/5990230007F/9385 417

How to get better

